UNITED STATES OF AMERICA				/ OFGS FILE NO.;	
COMBINED DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION				P/3117-3/	
As a below named inventor, I hereby declare that: my residence, post office address and citizenship are as stated below next to my name; that I verily believe that I am the original, first and sole inventor (if only one name is listed below) or a joint inventor (if plural inventors are named) of the subject matter which is claimed and for which a patent is sought on the invention entitled: SIM CARD MOUNTING STRUCTURE OF MOBILE PHONE					
the specification of which is attached hereto, unless the following box is checked: state that the state of the state of the state patent application Number or PCT International patent application number and was amended on (if any).					
I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose all information known to be material to patentability in accordance with Title 37, Code of Federal Regulations, § 15.6. I hereby claim priority benefits under Title 35, United States Code § 119 of any foreign application(s) for patent or inventor's certificate or United States provisional application(s) listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:					
Prior Foreign or Provisional Applicat					
COUNTRY	APPLICATION NUMBER DATE OF F (day, month,				PRIORITY CLAIMED UNDER 35 U.S.C. 119
Japan	006	686/2001	15,1,20	01	YES _X NO
					YES NO
					YES NO
I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application in so and isolated in the prior United States application in the manus provided by the first paragraph of Title 35, United States Code, §112, 1 acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, §1.50 which became available between the filing date of the prior application and the national or PCT international filing date of this application.					
UNITED STATES APPLICATION NUMBER	DATE OF FILING (day, month, year)			STATUS (patented, pending, abandoned)	
				(pa	penang, abancenea)
I hereby appoint OSTROLENK, 1	FABER, GE	RB & SOFFEN, and the n	nembers of the firm, Mar	rin C. Soffen - R	eg. No. 17.542; Samuel
I hereby appoint OSTROLENK, FARER, GERB & SOFFEN, and the members of the firm, Marvin C. Soffen Reg. No. 17,542, Samuel H. Weiner - Reg. No. 18,101 Leonen M. Berliner - Reg. No. 18,531 Exhert S. Feber - Reg. No. 24,222; Edward, A. Meillen, Reg. No. 24,247, Stanley H. Liaberstein - Reg. No. 22,409; Steven I. Weisbard - Reg. No. 27,409; Steven I. Soffen - Reg. No. 30, 10,53 Leone A. Finder - Reg. No. 30,173 William O. Grey, III - Reg. No. 30,444 and Log. No. 26, 10, 10, 10, 10, 10, 10, 10, 10, 10, 10					
·				DIRECT TELEPHONE CALLS TO: (212) 382-0700	
I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the little so made are punishable by fine or imprisonment, or both, under Section [00] of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.					
FULL NAME OF SOLE OR FIRST INVENT		INVENTOR'S SIGNATURE	2 2	(額)	DATE
KATSUYA SAKAGUCHI		Katsuya	Sakaguchi	(13)	December13,2001
RESIDENCE	-			COUNTRY OF C	ITIZENSHIP
Tokyo, Japan				Japan	
POST OFFICE ADDRESS	n 7 1	Chiba E -1-	Md	less mail	
c/o NEC Corporation, 7-1, Shiba 5-chome, Minato-ku, Tokyo, Japan FULL NAME OF SECOND JOINT INVENTOR (FANY) INVENTOR'S SIGNATURE					
TOYOSHI SAITO	JR (IF ANT)	70 YASHU	Saitor	- (香)	December 13, 2001
RESIDENCE			7-01 00	COUNTRY OF C	
Tokyo, Japan Japan					
POST OFFICE ADDRESS					
c/o NEC Corporation, 7-1, Shiba 5-chome, Minato-ku, Tokyo, Japan					
FULL NAME OF THIRD JOINT INVENTOR (IF ANY)		INVENTOR'S SIGNATURE			DATE
RESIDENCE				COUNTRY OF C	ITIZENSHIP
POST OFFICE ADDRESS					